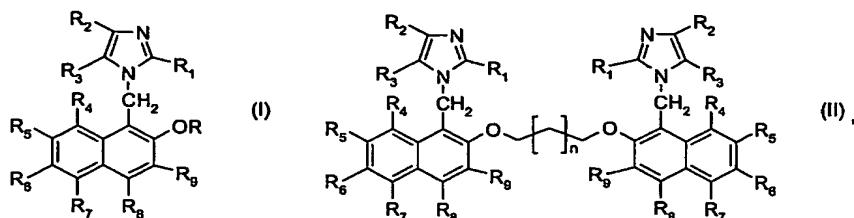


Claims

- 1. Compounds of the general formulae (I) and (II):**



where

- R₁, R₂ and R₃ each independently of one another are H; C₁₋₁₇alkyl;
C₃₋₁₂cycloalkyl, optionally substituted by C₁₋₄alkyl groups;
C₄₋₂₀cycloalkyl-alkyl, optionally substituted by C₁₋₄alkyl groups;
C₆₋₁₀aryl, optionally substituted by 1-3 C₁₋₄alkyl groups, -CN, Hal, OH, or C₁₋₁₀alkoxy;
C₇₋₁₅phenylalkyl, optionally substituted by 1-3 C₁₋₄alkyl groups;
C₃₋₁₂alkenyl; C₃₋₁₂alkynyl; or aromatic or aliphatic C₃₋₁₂acyl;
R₄, R₅, R₆, R₇, R₈, and R₉ each independently of one another are H; C₁₋₁₇alkyl;
C₃₋₁₂cycloalkyl, optionally substituted by C₁₋₄alkyl groups;
C₄₋₂₀cycloalkyl-alkyl, optionally substituted by C₁₋₄alkyl groups;
C₆₋₁₀aryl, optionally substituted by 1-3 C₁₋₄alkyl groups;
C₇₋₁₅phenylalkyl, optionally substituted by 1-3 C₁₋₄alkyl groups;
C₃₋₁₇alkenyl; C₃₋₁₂alkynyl; C₁₋₁₂alkoxy; or OH; for formula (I)
R is C₁₋₁₂alkyl; C₃₋₁₂cycloalkyl, optionally substituted by C₁₋₄alkyl groups;
C₄₋₂₀cycloalkyl-alkyl, optionally substituted by C₁₋₄alkyl groups;
C₆₋₁₀aryl, optionally substituted by 1-3 C₁₋₄alkyl groups;
C₇₋₁₅phenylalkyl, optionally substituted by 1-3 C₁₋₄alkyl groups;
C₃₋₁₂alkenyl; or C₃₋₁₂alkynyl; and for formula (II) n = 2 - 12.
2. Compounds according to Claim 1, where R₁, R₂ and R₃ each independently of one another are H; C₁₋₁₂alkyl; phenyl; or C₇₋₁₅phenylalkyl, optionally substituted by 1-3 C₁₋₄alkyl groups.
3. Compounds according to Claim 2, where R₂ and R₃ are each H; and R₁ is C₁₋₁₂alkyl; phenyl; or C₇₋₁₅phenylalkyl, optionally substituted by 1-3 C₁₋₄alkyl groups.

2. Compounds according to Claim 1, where R₁, R₂ and R₃ each independently of one another are H; C₁₋₁₂alkyl; phenyl; or C₇₋₁₅phenylalkyl, optionally substituted by 1-3 C₁₋₄alkyl groups.
3. Compounds according to Claim 2, where R₂ and R₃ are each H; and R₁ is C₁₋₁₂alkyl; phenyl; or C₇₋₁₅phenylalkyl, optionally substituted by 1-3 C₁₋₄alkyl groups.

3. Compounds according to Claim 2, where R₂ and R₃ are each H; and R₁ is C₁₋₁₂alkyl; phenyl; or C₇₋₁₅phenylalkyl, optionally substituted by 1-3 C₁₋₄alkyl groups.

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4. Compounds according to one of Claims 1 to 3, where for formula (I) R is C₁₋₁₂alkyl; or is C₃₋₁₂alkenyl; and for formula (II) n = 6 - 12.
5. Compounds according to one of Claims 1 to 4, where the radicals R₄ to R₉ are a hydrogen atom.
6. Compounds according to Claim 1, where R₁ = methyl, R₂₋₉ are each a hydrogen atom, R = n-butyl, n-nonyl, n-dodecyl, or allyl, and n = 8.
7. Use of a compound according to Claim 1 as accelerator in epoxy resin compositions.
8. Curable composition comprising
 - a) an epoxy resin whose epoxide content is from 0.1 to 11 epoxide equivalents/kg,
 - b) from 1 to 10 parts by weight, based on the overall composition from the components a) to d), of a compound according to Claim 1,
 - c) a curing agent for the epoxide resin, calculated such that per epoxide group there are from 0.5 to 1.5 functional groups of the curing agent, and optionally
 - d) an additive customary in epoxy resin technology.
9. Composition according to Claim 8, characterized in that the curing agent is selected from the amine group.
10. Composition according to Claim 9, characterized in that the curing agent is a polyoxypropylenediamine.
11. Composition according to Claim 8, characterized in that the epoxy resin is a glycidyl ether, glycidyl ester, N-glycidyl or N,O-glycidyl derivative of an aromatic or heterocyclic compound, or a cycloaliphatic glycidyl compound.
12. Use of a curable composition according to Claim 8 as a compression moulding compound, sinter powder, encapsulating system, casting resin, for producing prepregs and laminates using the resin infusion method, wet layup method and injection methods.